Meeting Minutes PDCC Ad Hoc Prepared by: Chad Jones 16 July 2024 19:00 PM EDT

19:00 Meeting called to order.

Meeting started by the Ad Hoc Chair, Chad Jones.

19:02 The Chair starts reviewing agenda slides.

19:03 The Chair covered the IEEE SA Patent Policy, code of ethics and conduct, individual process, equitable consideration of all viewpoints, and IEEE SA Copyright Policy (slides 4-8 in the agenda deck).

19:05 The first agenda item was the Call for Interest consensus building presentation: https://ieee802.org/3/cfi/0724_1/CFI_01a_0724.pdf. Q&A started at 19:18. The presentation concluded at 19:30.

19:31 the second agenda item was a presentation on the compatibility of non-PD MDI: https://www.ieee802.org/3/ad_hoc/PDCC/public/brandt_3pdcc_01a_0724.pdf, and it generated a protracted discussion which was the intent of the presentation. Q&A and discussion ended at 20:31.

20:31 The next scheduled meeting is at the standard weekly Wednesday meeting, scheduled for 24 July 2024 at 1PM EDT. See the 802.3 call and meeting calendar for details: https://www.ieee802.org/3/calendar.html.

20:32 The Chair asked if there was any other business, none responded. Having exhausted the agenda, the meeting was adjourned.

Attendance (from Webex and IMAT – noted by W, I):

Name	Employer; Affiliation	Present
Bob Voss	Panduit Corp.; Panduit Corp.	W
Chad Jones	Cisco Systems, Inc.; Cisco Systems, Inc.	W, I
David Brandt	Rockwell Automation; Rockwell Automation	W, I
Debajyoti Pal		1
Francois Beauregard	Belden; Belden	W, I
Frank SS. Wang	Realtek; Realtek	W
Geoff Thompson	Unemployed; Unaffiliated	W, I
George Zimmerman	CME Consulting; CME Consulting/APL Group, Cisco	W, I
	Systems, Marvell, OnSemi, and SenTekse	
Heath Stewart	ADI; ADI	1
Heiko Strohmeier	Robert Bosch GmbH; Robert Bosch GmbH	W, I
Hideki Goto	Toyota Motor Corporation; Toyota Motor Corporation	W, I
James Withey	Fluke Corporation; Fluke Corporation	W, I
Jason Potterf	Cisco; Cisco	W
Jay Cordaro	ADI; ADI	W, I
Kinya Yamazaki	APRESIA Systems; APRESIA Systems	1
Kirsten Matheus	BMW Group; BMW Group	1

Name	Employer; Affiliation	Present
Leonard Stencel	TDK; TDK	1
Luis Pineda	LP Tech Advisors, LLC; LP Tech Advisors, LLC	W, I
Mabud Choudhury	OFS; OFS	W, I
Masato Shiino	FURUKAWA ELECTRIC; FURUKAWA ELECTRIC	W, I
Masayuki Hoshino	Continental; Continental	W, I
Matthias Wendt	Signify; Signify	W, I
Michael Paul	Analog Devices Inc.; Analog Devices Inc.	1
Michal Brychta	ADI; ADI	W, I
Norm Swenson	Point2; Point2	W, I
Paul Vanderlaan	UL LLC; UL LLC	1
Peter Jones	Cisco Systems, Inc.; Cisco Systems, Inc.	1
Ron Tellas	Belden; Belden	W, I
Sam Sambasivan	AT&T AT&T	W, I
Shuang Yin		1
Shun-Sheng Wang	Realtek Semiconductor Corp., Realtek Semiconductor Corp.	1
Stephan Kehrer	Hirschmann Automation and Control GmbH; Hirschmann	W, I
Stephan Schreiner	Rosenberger; Rosenberger	W, I
takeshi hirose	AGC; AGC	W, I
Tomohiro Kikuta	Orbray Co., Ltd.; Orbray Co., Ltd.	W, I
Xiliang Luo	Apple; Apple	W
Yan Zhuang	Huawei; Huawei	W, I
Yasuhiro Hyakutake	Orbray Co., Ltd.; Orbray Co., Ltd.	1
Yuji Watanabe	AGC; AGC	W, I